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(54) **METHODS AND APPARATUS TO PROTECT MEMORY REGIONS DURING LOW-POWER STATES**

(58) **Field of Classification Search**
CPC combination set(s) only.
See application file for complete search history.

(71) Applicant: **Intel Corporation**, Santa Clara, CA (US)

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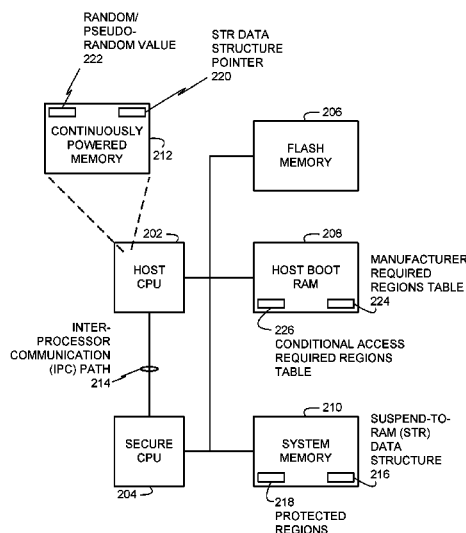
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G06F 3/06 (2006.01)
(Continued)

(52) **U.S. Cl.**
CPC **G06F 3/0625** (2013.01); **G06F 1/3234** (2013.01); **G06F 3/0622** (2013.01); **H04L 9/3247** (2013.01)

(57) **ABSTRACT**

A disclosed example involves managing power states, signing a suspend-to-RAM (STR) data structure by: generating a header key, a scatter/gather table key and a dynamic random access memory (DRAM) key using a root key generated by the secure processor. Generating a header signature using the header key, the header signature based on a table header and a random or pseudo-random value. Generating a scatter/gather table signature using the scatter/gather table key, the scatter/gather table signature based on a scatter/gather table header and a random or pseudo-random value. Generating a DRAM signature using the DRAM key and a value from a region of DRAM. Storing the header signature, the scatter/gather table signature and the DRAM signature in the STR data structure. Resume the processor system from the low-power mode when the data structure is valid based on a comparison of a first signature and a second signature.

21 Claims, 11 Drawing Sheets



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H04L 9/32 (2006.01)
G06F 1/32 (2006.01)

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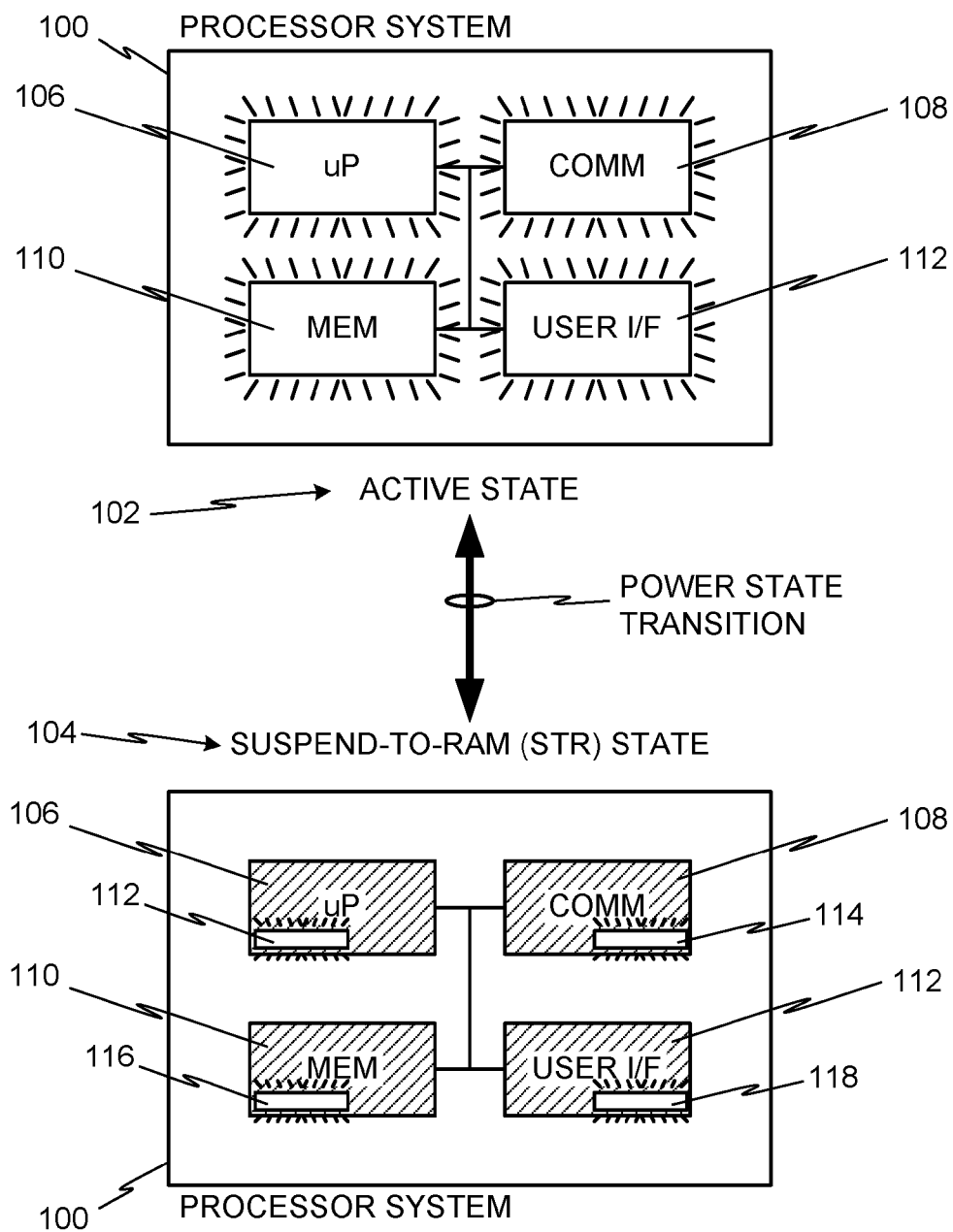


FIG. 1

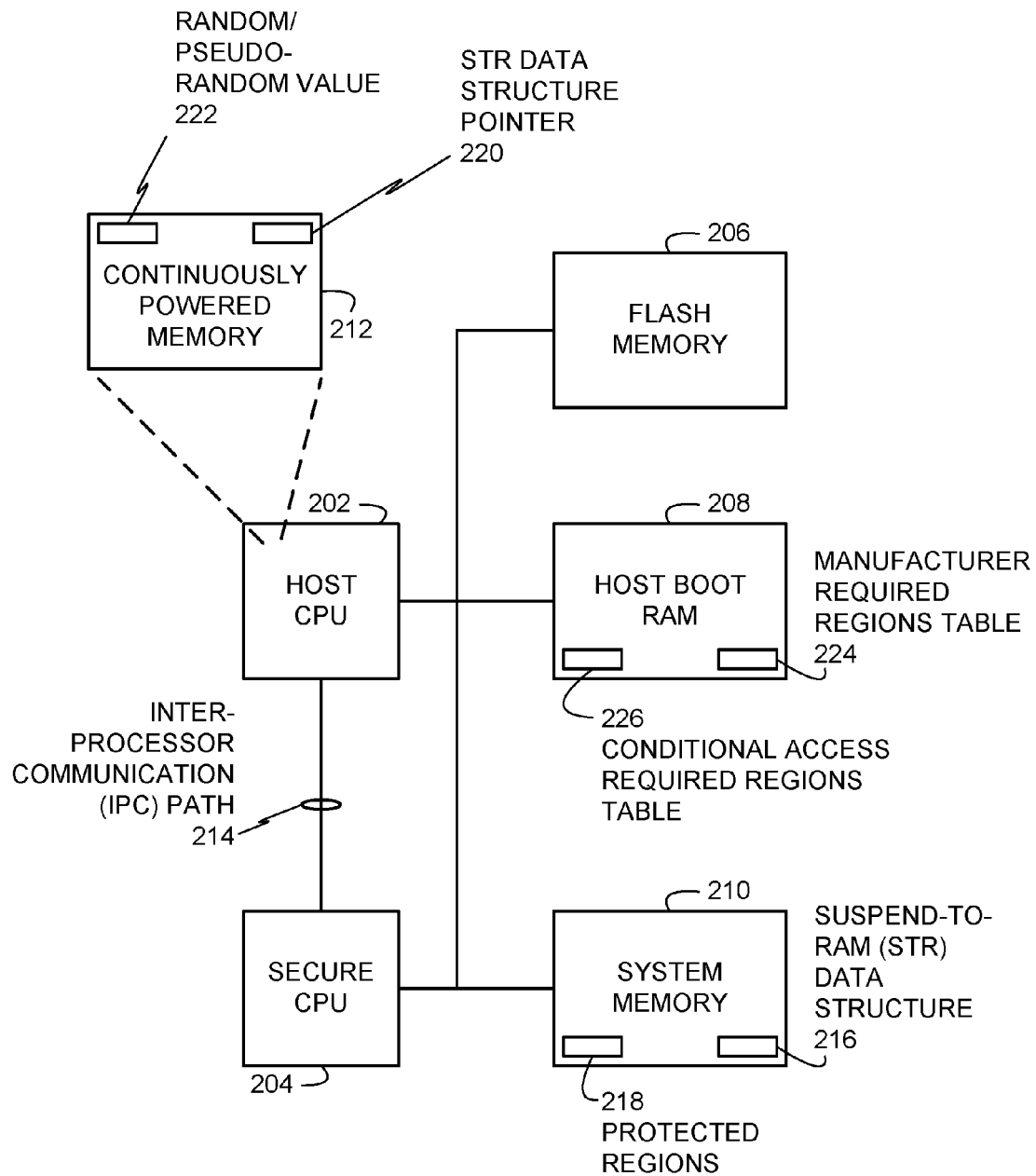
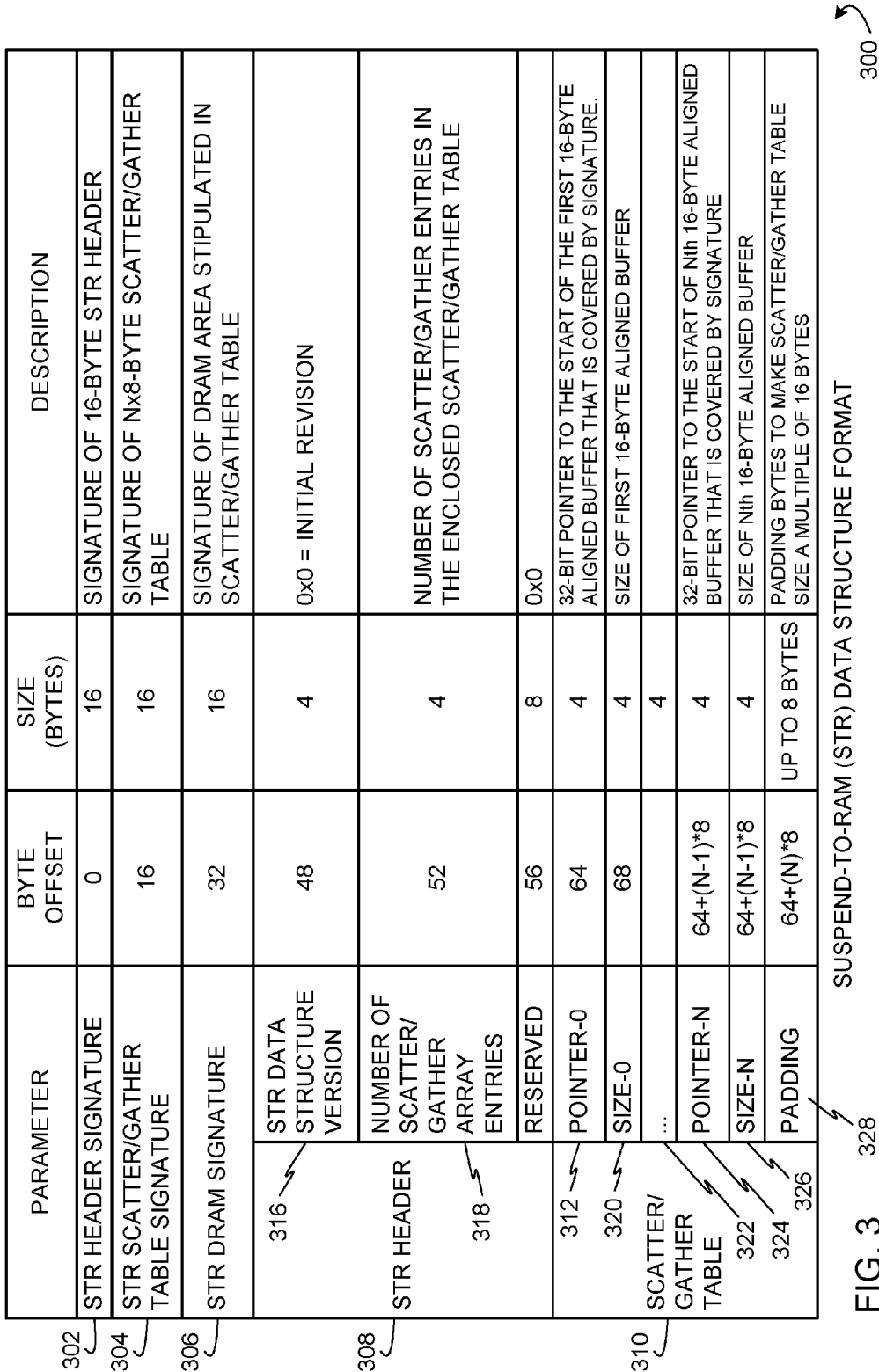


FIG. 2



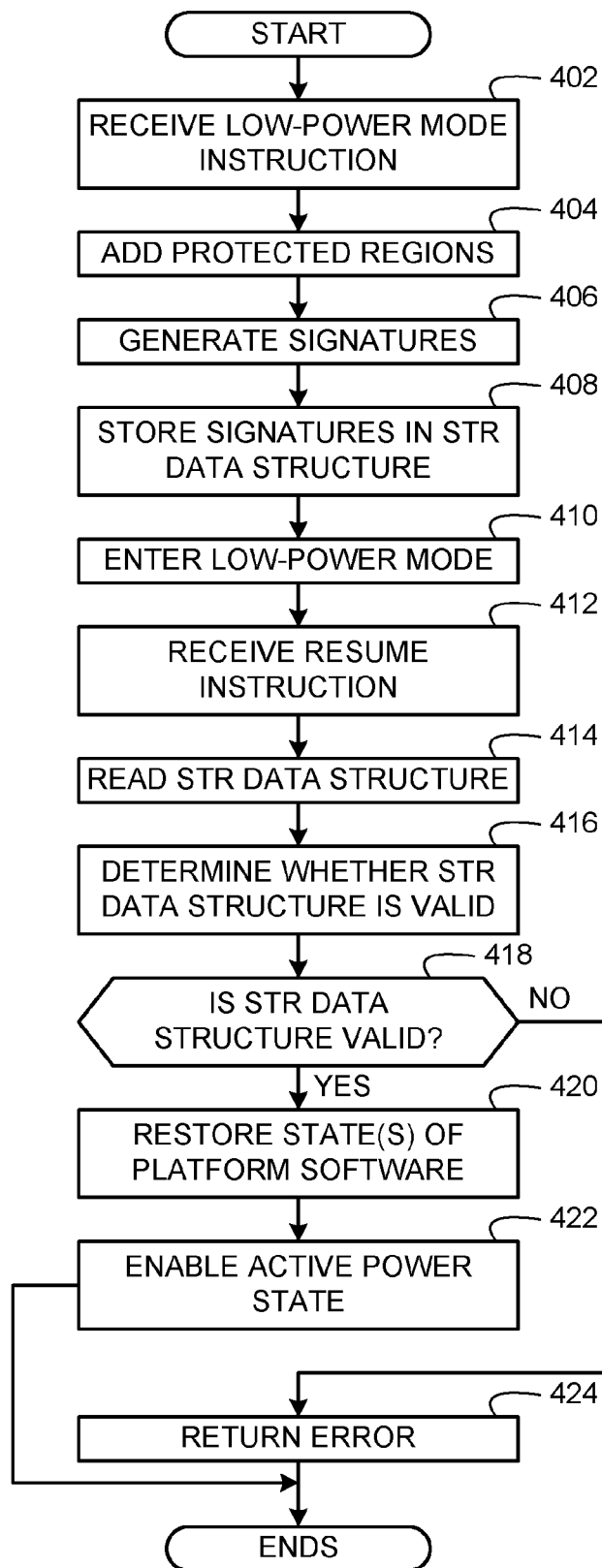


FIG. 4

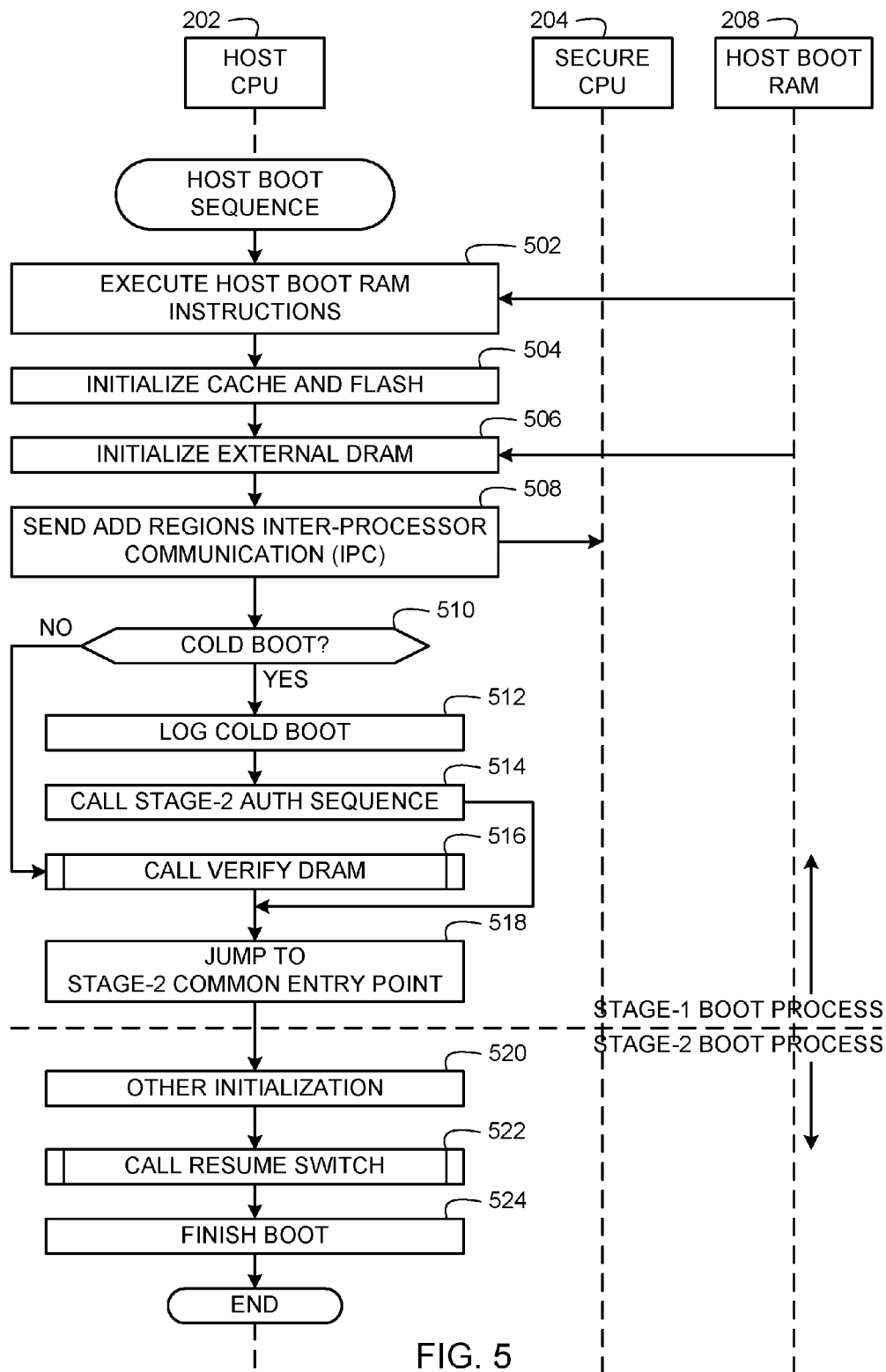


FIG. 5

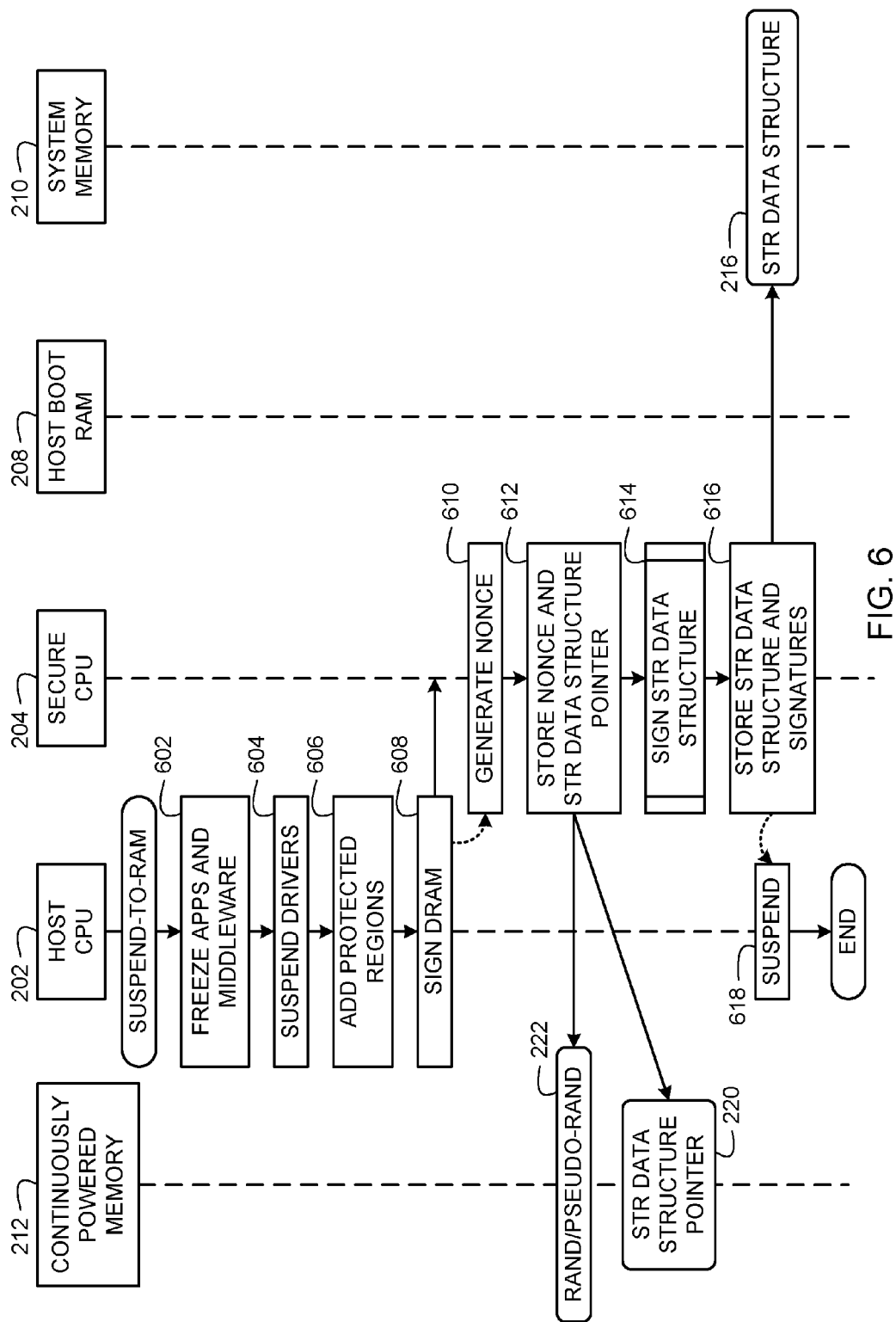


FIG. 6

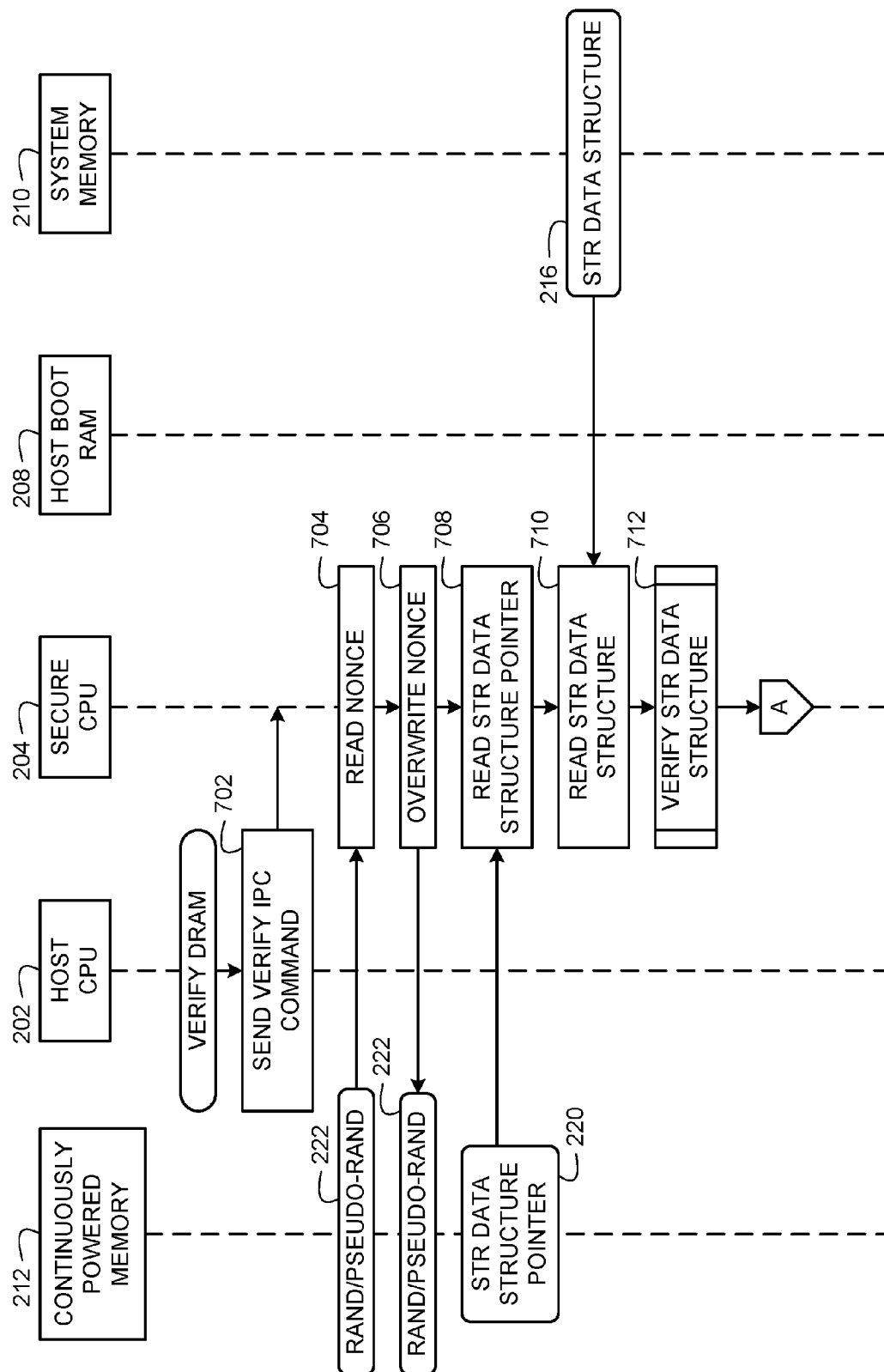
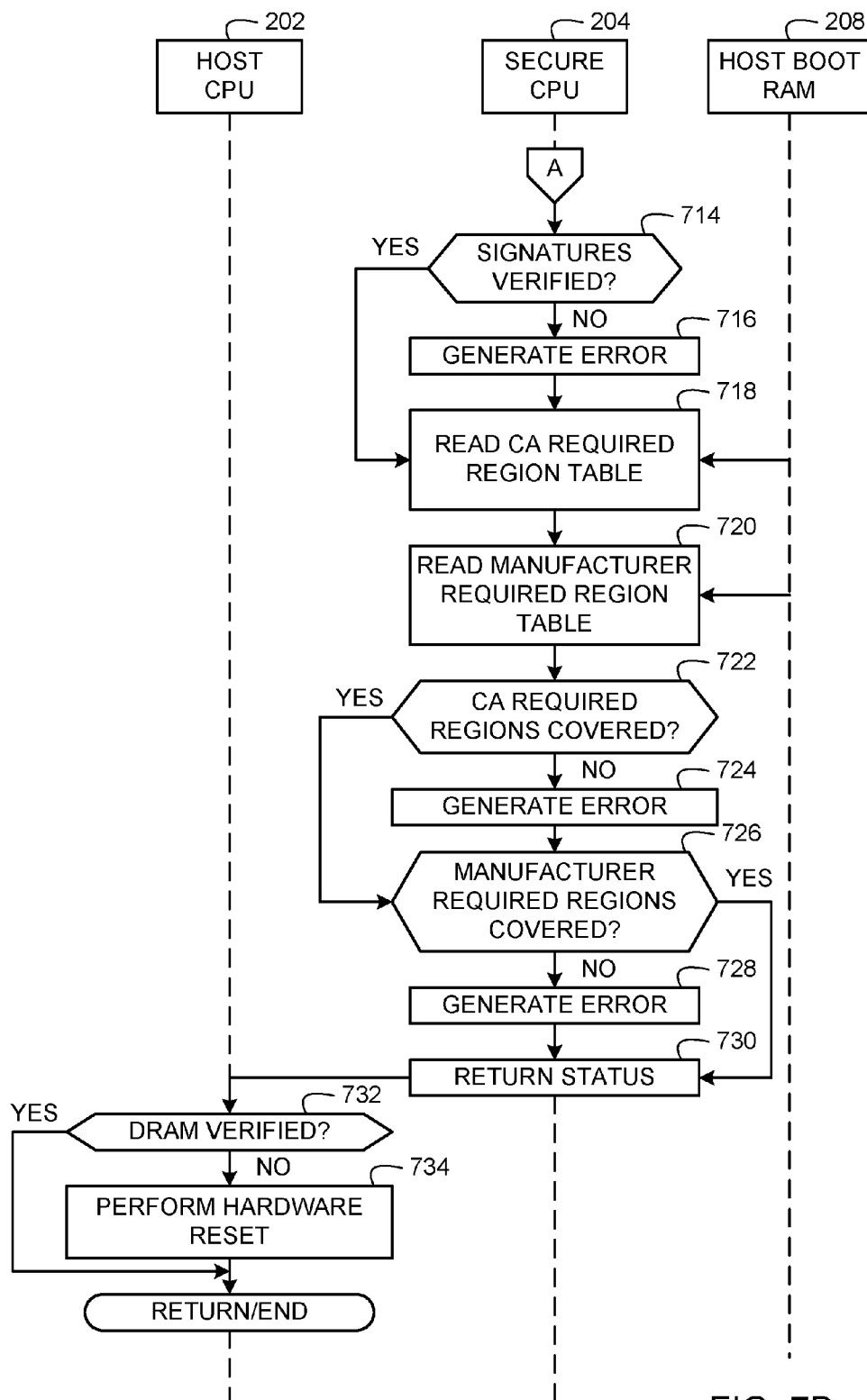


FIG. 7A



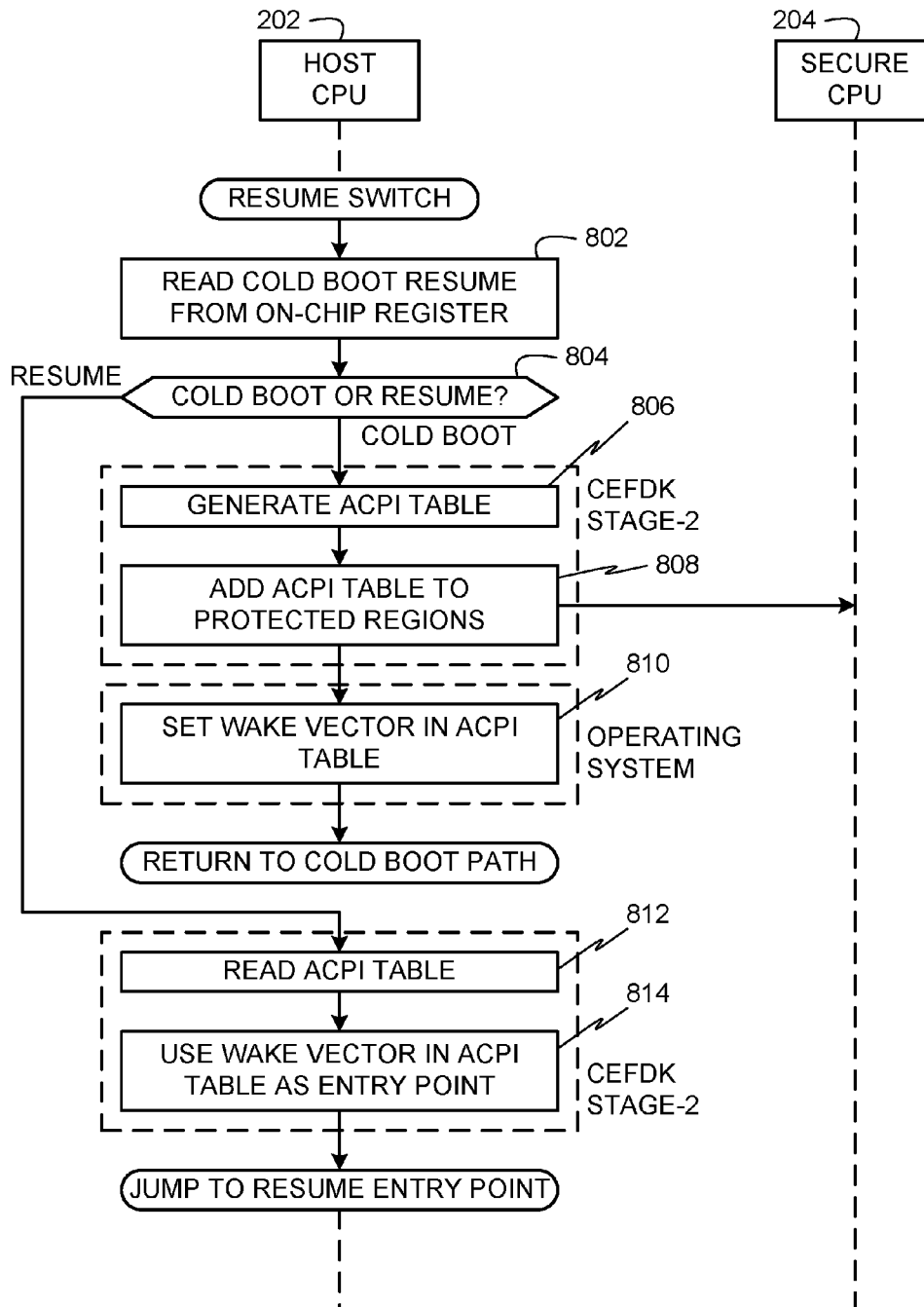


FIG. 8

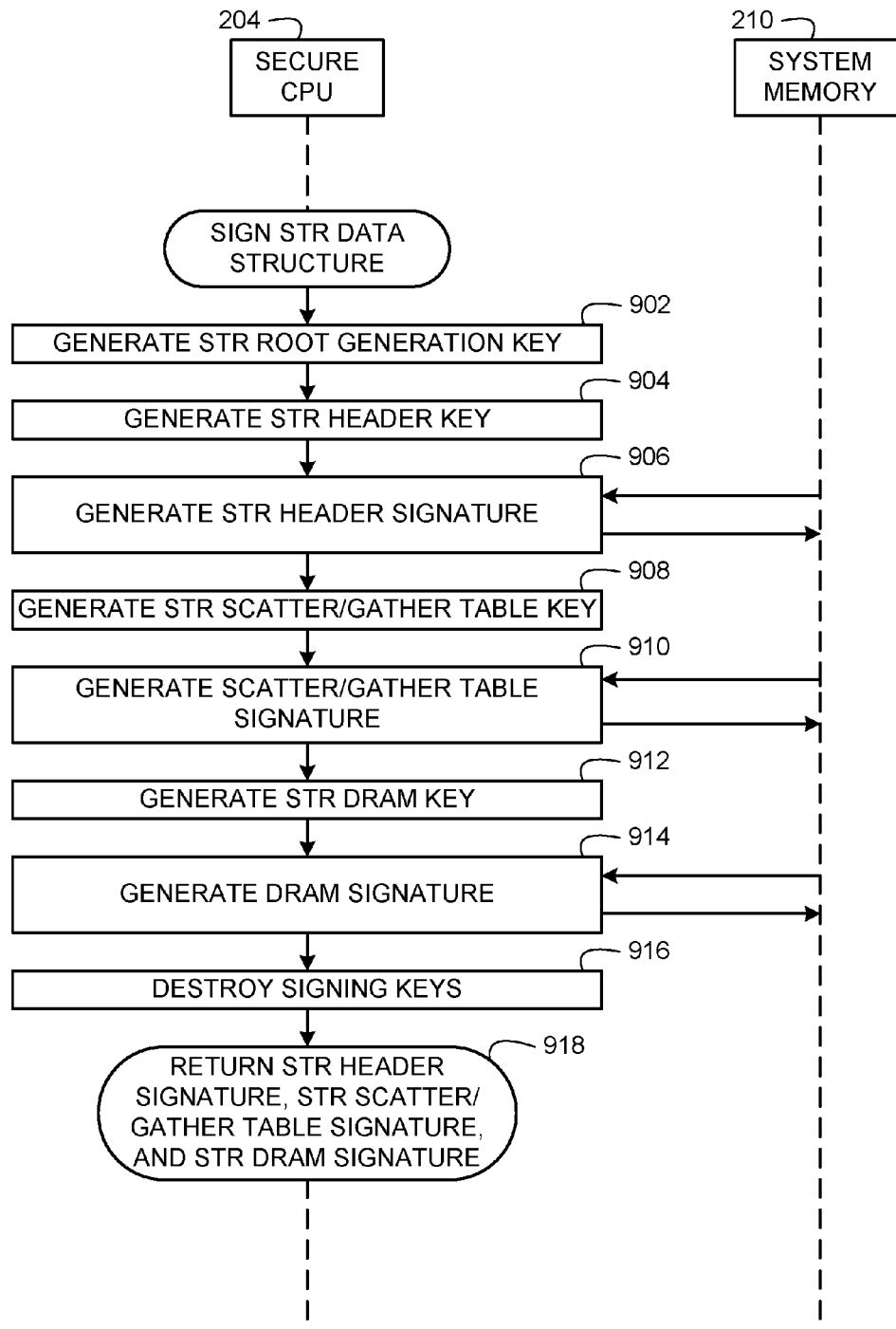


FIG. 9

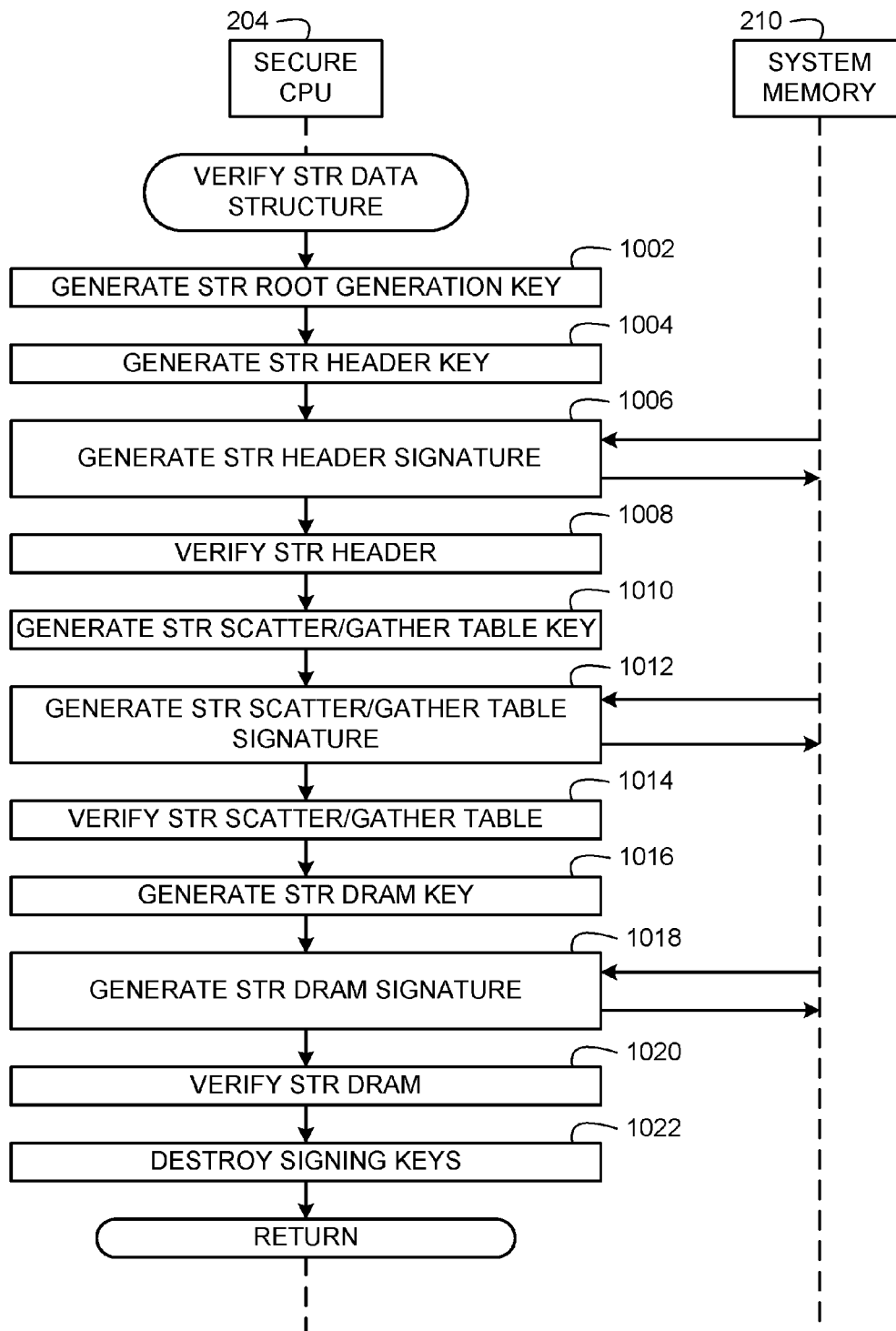


FIG. 10

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METHODS AND APPARATUS TO PROTECT MEMORY REGIONS DURING LOW-POWER STATES

RELATED APPLICATIONS

This patent arises from a continuation of U.S. patent application Ser. No. 14/639,854, filed Mar. 5, 2015, which is a continuation of U.S. patent application Ser. No. 13/976,342, filed Jun. 26, 2013, now U.S. Pat. No. 8,978,135, which is a national stage entry of International Patent Application No. PCT/US2012/055580, filed Sep. 14, 2012. U.S. patent application Ser. No. 14/639,854, U.S. patent application Ser. No. 13/976,342 and International Patent Application No. PCT/US2012/055580 are hereby incorporated herein by reference in their entireties.

FIELD OF THE DISCLOSURE

The present disclosure relates generally to processor systems and, more particularly, to methods and apparatus to protect memory regions of a processor system during low-power states.

BACKGROUND

Energy Star standards define power levels for acceptable low-power consumption ratings of electronic devices. To comply with such Energy Star standards, electronic devices often implement one or more low-power modes. Such low-power modes include a full-off power state, a suspend-to-RAM (random access memory) power state, a suspend-to-disk (hibernate) state, and/or one or more types of standby power states. The full-off power state typically consumes the lowest amount of power of any platform power state. However, the full-off power state requires the platform to complete a full boot of the platform software after a power-on operation is re-applied. Such a full boot incurs undesirable boot latencies.

The suspend-to-RAM power state is an alternative to the full-off state. The suspend-to-RAM power state retains the operating state of the platform software as it existed immediately prior to entering the suspend-to-RAM power state. Because the platform software operating state is retained in RAM during the suspend-to-RAM power state, the platform software need only execute portions of a boot process to continue where it left off before entering the suspend-to-RAM state.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 illustrates an example processor system that transitions between an active power state and a suspend-to-RAM (random access memory) power state.

FIG. 2 illustrates example components of the example processor system of FIG. 1 that may be used to protect memory regions during low-power states of the processor system.

FIG. 3 illustrates an example data structure format for storing signatures and location information for protected regions of platform software stored in system memory during a low-power state.

FIG. 4 illustrates an example flow diagram representative of computer readable instructions that may be executed to transition the processor system of FIG. 1 between a low-power mode power state and an active power state in accordance with the teachings of this disclosure.

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FIG. 5 illustrates an example flow diagram representative of computer readable instructions that may be executed to perform a host boot sequence to boot a processor system during a cold boot or a resume from a low-power state.

FIG. 6 illustrates an example flow diagram representative of computer readable instructions that may be executed to transition a processor system to a low-power state.

FIGS. 7A and 7B illustrate an example flow diagram representative of computer readable instructions that may be executed to verify protected regions of system memory storing data for a software platform operating state.

FIG. 8 illustrates an example flow diagram representative of computer readable instructions that may be executed to boot a processor system under a cold boot process or a resume process to resume from a low-power state.

FIG. 9 illustrates an example flow diagram representative of computer readable instructions that may be executed to generate signatures useable to authenticate a suspend-to-RAM data structure.

FIG. 10 illustrates an example flow diagram representative of computer readable instructions that may be executed to verify the validity of a suspend-to-RAM data structure.

DETAILED DESCRIPTION

Example methods, apparatus, systems, and articles of manufacture disclosed herein enable protecting regions of memory during low-power states of processor systems. Disclosed examples are described herein in connection with a suspend-to-RAM (random access memory) power state. However, examples disclosed herein may additionally or alternatively be used to protect regions of memory during other power states of processor systems.

Processor systems may be configured to transition between different power states, ranging from full-power-on to fully off states. These different power states are provided to conserve power. Intermediate power states such as a suspend-to-RAM power state is sometimes used to strike a balance between lower power consumption and having the ability to resume operation (e.g., exit the suspend-to-RAM power state to a fully on state) relatively faster than is otherwise possible when performing a cold boot from a fully off state or a suspend-to-disk (e.g., hibernate) power state. A suspend-to-RAM power state is a low-power state in which a processor system retains a state or states in random access memory of platform software (e.g., an operating system (OS) and/or applications) that is running when the processor system initiates its transition to the suspend-to-RAM state. When the processor system resumes or exits the suspend-to-RAM state to a fully on power state, the processor system need not execute the entire platform boot software as required when performing a cold boot from a fully off state or a hibernate state. In prior systems, not executing the entire platform boot software upon resume introduces potential security risks because the platform system memory can be compromised while it is in the suspend-to-RAM power state. For example, malicious code can be written to memory regions storing the operating state(s) of the platform software. Upon resume from the suspend-to-RAM state of such prior systems, the compromised platform software could be executed, and allow an attacker to take control of the system or to otherwise compromise the system.

Unlike prior systems having security vulnerabilities when in a suspend-to-RAM power state, examples disclosed herein may be used to implement a trusted resume to provide platform software and system integrators with features to

protect the platform software while processor systems are in suspend power states or low-power states (e.g., a suspend-to-RAM power state).

FIG. 1 illustrates an example processor system 100 that may be used to implement the examples disclosed herein to protect memory regions during low-power states of the processor system 100. In the illustrated example, the processor system 100 is shown transitioning between an active power state 102 and a suspend-to-RAM (STR) power state 104. In the active power state 102 of the illustrated example, a microprocessor (uP) subsystem 106, a communication subsystem 108, a memory subsystem 110, and a user interface (I/F) subsystem 112 are shown fully powered. In the suspend-to-RAM power state 104 of the illustrated example, the microprocessor subsystem 106, the communication subsystem 108, the memory subsystem 110, and the display subsystem 112 are shown in a low-power state in which power is removed from portions thereof.

In the illustrated example, the microprocessor subsystem 106, the communication subsystem 108, the memory subsystem 110, and the display subsystem 112 are only partially powered as power remains applied to portions 114, 116, 118, and 120. In this manner, the powered portions 114, 116, 118, and 120 are useable for resuming the active power state 102 of the processor system 100 from the suspend-to-RAM power state 104. In the illustrated example, the powered microprocessor portion 112 includes continuously powered memory (e.g., continuously powered memory 212 of FIG. 2) to store an address or a pointer to an authentication table (e.g., a pointer to a suspend-to-RAM data structure 216 of FIG. 2) storing security parameters (e.g., signatures) and memory address locations of platform software stored in RAM (e.g., a system memory 210 of FIG. 2) during the suspend-to-RAM power state 104. In the illustrated example, the powered communication subsystem portion 114 may include power to a wake-on-LAN (local area network) circuit or other wake-on-network circuit to resume the processor system 100 using network communications. In the illustrated example, the powered memory subsystem portion 116 includes system memory (e.g., the system memory 210 of FIG. 2) used to store the state or states of platform software when the processor system 100 is in the suspend-to-RAM power state 104. The powered user interface portion 118 of the illustrated example may include power to detect de-pressing of a power/wake button or de-pressing of a keyboard key or other user input of any other type of human interface device (HID).

Examples disclosed herein enable using a trusted resume to transition the processor system 100 from the suspend-to-RAM power state 104 to the active state 102 by providing various example protection features or trust features. In the illustrated examples, a trusted resume (a) substantially reduces the ability of malicious attacks to change contents of system memory (e.g., the system memory 210 of FIG. 2) that stores state(s) of the platform software when in a low-power mode (e.g., the suspend-to-RAM power state 104); (b) substantially reduces the ability of performing system memory replay attacks and/or rollback attacks; (c) enables designating multiple authenticated/non-authenticated regions in system memory (e.g., the system memory 210 of FIG. 2); (d) enables a host processor (e.g., a host processor 202 of FIG. 2) to generate/authenticate a signature for selected protected regions (e.g., protected regions 218 of FIG. 2) without knowledge of the signing key; and (e) enables hardware manufacturers (e.g., of host processors (e.g., the host processor 202 of FIG. 2), secure processors (e.g., a secure processor 204 of FIG. 2), and/or processor

systems) and third-party vendors to specify amounts (e.g., at least minimal amounts) of protected regions (e.g., the protected regions 218 of FIG. 2) that are to be protected by using authentication and verification processes under the trusted resume techniques disclosed herein. As described in detail below, examples disclosed herein provide these protections by authenticating/signing critical portions of system memory (e.g., dynamic random access memory (DRAM)) during transitions into the suspend-to-RAM power state 104, and verifying those authenticated/signed critical portions of system memory when resuming out of the suspend-to-RAM state 104 into the active power state 102. In disclosed examples, critical portions of a boot sequence are aggregated during the boot sequence such that stage N of the boot sequence adds protected regions (e.g., the protected regions 218 of FIG. 2) about stage N+1. To guard against rollback attacks, a random or pseudo-random value (e.g., a nonce value) is incorporated into the authenticating/signing process and is stored in continuously powered memory (e.g., continuously powered memory 212 of FIG. 2) during the suspend-to-RAM power state 104.

FIG. 2 illustrates example components of the example processor system 100 of FIG. 1 that may be used to manage power state transitions of the processor system 100. In the illustrated example, the processor system 100 includes a host processor (CPU) 202, a secure processor (CPU) 204, a flash memory 206, a host boot RAM 208, a system memory 210, and a continuously powered memory 212. The processor system 100 of the illustrated example can be, for example, a server, a personal computer, a mobile phone (e.g., a cell phone), a personal digital assistant (PDA), an Internet appliance, a DVD player, a CD player, a digital video recorder, a Blu-ray player, a gaming console, a personal video recorder, a set-top box, or any other type of computing device.

In the illustrated example, the host CPU 202, the secure CPU 204, and the host boot RAM 208 are located on the same silicon die so that inter-processor communications between the processors 202 and 204 and communications with the host boot RAM 208 are not exposed external to the silicon die. This provides further security in the examples disclosed herein by substantially reducing external accessibility to security communications and security data exchanged between the host CPU 202, the secure CPU 204, and/or the host boot RAM 208. Also in the illustrated example, the flash memory 206 and the system memory 210 are located on separate integrated circuits that are located on the same circuit board as the silicon die containing the host CPU 202, the secure CPU 204, and the host boot RAM 208.

The processors 202 and 204 can be implemented by using processors or controllers from any desired family or manufacturer. In the illustrated example, an inter-processor communication (IPC) path 214 is provided between the processors 202 and 204 to enable inter-processor communications therebetween. In the illustrated example, the host processor 202 includes the continuously powered memory 212 which may be implemented using an embedded static random access memory (SRAM). Because SRAM is a volatile memory, it remains powered (or a portion thereof remains powered) in the illustrated examples during low-power modes such as the suspend-to-RAM power state 104 of FIG. 1 so that data stored therein is persisted.

The processors 202 and 204 are in communication with the flash memory 206, the host boot RAM 208, and the system memory 210. Although not shown, the processors 202 and 204 may also be in communication with a mass memory (e.g., a hard drive) that stores an operating system

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and/or applications). In the illustrated example, the flash memory **206** is a non-volatile memory used to store parameters (e.g., security parameters and/or other parameters that are not persisted in volatile memories when power is completely removed) for booting the processor system **100**. The host boot RAM **208** of the illustrated example stores boot code for booting the processor system **100** and loading an operating system. The host boot RAM **208** of the illustrated example also stores a manufacturer required region table **224** to indicate protected regions (e.g., the protected regions **218** of FIG. 2) of platform software stored in the system memory **210**. In the illustrated example, a hardware manufacturer of the host CPU **202**, the secure CPU **204**, the processor system **100**, and/or one or more hardware components of the processor system **100** specifies the regions (e.g., the protected regions **218**) indicated in the manufacturer required region table **224** so that those specified regions are protected using examples disclosed herein during the suspend-to-RAM power state **104** (FIG. 1) to implement a trusted resume.

In the illustrated example, the host boot RAM **208** also stores a conditional access (CA) required regions table **226** (e.g., a third-party required regions table) to indicate third-party-specified protected regions (e.g., the protected regions **218** of FIG. 2) of platform software stored in the system memory **210**. In the illustrated examples, the CA required regions table **226** is accessible and modifiable by third-parties for after-market products or developments (e.g., after-market software and/or hardware installations in the processor system **100**). For example, one or more third-parties specify the regions (e.g., the protected regions **218**) indicated in the CA required regions table **226** so that those specified regions are protected using examples disclosed herein during the suspend-to-RAM power state **104** (FIG. 1) to implement a trusted resume. In the illustrated examples, the CA required regions table **226** is copied into and authenticated from the host boot RAM **208** by the secure CPU **204** before the host CPU **202** begins executing instructions. In the illustrated examples, this happens during power state transitions in which the host CPU **202** boots from its reset vector (e.g., when resuming from the suspend-to-RAM power state **104** and/or during cold boots). In some examples, the CA required regions table **226** may be stored in an authenticated area of the host boot RAM **208** that is authenticated during a stage-1 boot loader (e.g., a stage-1 boot process shown in FIG. 5). Alternatively, the CA required regions table **226** could be implemented as part of stage-1 boot loader parameter blocks.

Using the manufacturer required regions table **224** and the CA required regions table **226** enables a hardware manufacturer and third parties to specify protected regions (e.g., the protected regions **218**) that they deem useful of protecting using examples disclosed herein. In some examples, the manufacturer required regions table **224** and the CA required regions table **226** may alternatively be implemented as a single table stored in the host boot RAM **208**.

The system memory **210** of the illustrated example stores the operating state(s) of platform software (e.g., an operating system and/or applications) that is running at the time that the processor system **100** transitions from the active power state **102** to the suspend-to-RAM power state **104** of FIG. 1. In this manner, the processor system **102** can transition out of the suspend-to-RAM power state **104** to the active power state **102** based on the platform software state(s) stored in the system memory **210** to resume the same operating state that it was in before entering the suspend-to-RAM power state **104**. For example, the operating system can resume to

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its same previous operating state, and applications that were previously loaded and running can resume to their same previous operating states.

The system memory **210** of the illustrated example is implemented using a volatile dynamic random access memory (DRAM). In some examples, to enable such a volatile DRAM to persist its data while in the suspend-to-RAM power state **104**, at least a minimal amount of power is supplied to the volatile DRAM, and the volatile DRAM is set to operate in a low-power, self-refresh mode in which data stored therein is persisted. In other examples, the system memory **210** may be implemented using a cache memory, a volatile SRAM, and/or any other type of volatile or non-volatile memory.

In the illustrated example, the system memory **210** stores a suspend-to-RAM (STR) data structure **216** and protected regions **218** of platform software. In the illustrated example, the protected regions **218** store select portions of platform software stored in the system memory **210** during the suspend-to-RAM power state **104**, and that are to be protected from attacks by signing or authenticating the protected regions **218** using security parameters (e.g., signatures). The STR data structure **216** stores addresses or pointers to the protected regions **218** of the platform software in the system memory **210** that are to be protected using examples disclosed herein during the suspend-to-RAM power state **104**. The STR data structure **216** of the illustrated example also stores the security parameters (e.g., signatures) for authenticating its data, and determining the validity of its data when resuming from the suspend-to-RAM power state **104**. An example format used to implement the STR data structure **216** in the illustrated examples is described below in connection with FIG. 3.

Attacks may be attempted on the processor system **100** by attackers modifying the information in the STR data structure **216** to point to different regions of the system memory **210** storing malicious software in an attempt to cause the host CPU **202** to execute such malicious code when the processor system **100** resumes to the fully active power state **102**. To detect whether such modifications exist in the STR data structure **216**, a verification process disclosed herein is performed during a trusted resume of the processor system **100**, and the verification process generates an error when it detects that the STR data structure **216** has been modified during the suspend-to-RAM power state **104**. In this manner, the host CPU **202** and/or the secure CPU **204** can prevent the processor system **100** from proceeding with the resume process so that the processor system **100** cannot be compromised by malicious software.

In the illustrated example, the continuously powered memory **212** of the host CPU **202** stores an example STR data structure pointer **220** that points to the storage location (e.g., a memory address) of the STR data structure **216** in the system memory **210**. During a trusted resume process to transition the processor system **100** out of the suspend-to-RAM power state **104**, the host CPU **202** can retrieve the STR data structure pointer **220** to locate the STR data structure **216** to enable verifying the integrity of the protected regions **218** of the platform software.

In the illustrated example, the continuously powered memory **212** of the host CPU **202** also stores an example random/pseudo-random value **222**. The random/pseudo-random value **222** of the illustrated example is used as a nonce value to generate verification signatures to confirm the integrity of the protected regions **218** of the platform software stored in the system memory **210** during the suspend-to-RAM power state **104**. In the illustrated example, the

random/pseudo-random value **222** is used to generate the verification signatures when the processor system **100** is transitioning into the suspend-to-RAM power state **104**. After generating the verification signatures, the random/pseudo-random value **222** is stored securely from undesired access in the continuously powered memory **212**. In this manner, when resuming out of the suspend-to-RAM power state **104**, the random/pseudo-random value **222** can be retrieved from the continuously powered memory **212** and used to verify the integrity of the protected regions **218** of the platform software. In the illustrated example, the random/pseudo-random value **222** is used to guard against replay/rollback attacks by serving as a unique secret value that is very difficult for any potential attacker to access or modify because it is stored in the continuously power memory **212** of the host CPU **202**. In addition, the random/pseudo-random value **222** is not easily predictable by an attacker because it is sufficiently random. In some examples, selecting a relatively large number of bits (e.g., 64 bits or more) for the random/pseudo-random value **222** also guards against replay/rollback attacks by making it very costly from a time and storage perspective for an attacker to launch a collision attack. For example, using a random/pseudo-random value **222** with a relatively large number of bits would require an attacker to store many DRAM/STR data structure permutations to launch a collision attack.

FIG. 3 illustrates an example suspend-to-RAM (STR) data structure format **300** that may be used to implement the STR data structure **216** of FIG. 2 to store signatures and location information to authenticate the protected regions **218** of platform software persisted in the system memory **210** of FIG. 1. In the illustrated example, the STR data structure format **300** includes an STR header signature field **302** for storing an STR signature at a byte offset of zero (0), and occupying a data size of 16 bytes in the STR data structure **216**. The STR header signature of the illustrated example is used to authenticate a STR header (e.g., stored in STR header fields **308**) of the STR data structure **216** to confirm that it is valid (e.g., it has not been altered or compromised during the suspend-to-RAM power state **104**).

The STR data structure format **300** of the illustrated example includes a STR scatter/gather table signature field **304** for storing a STR scatter/gather table signature at a byte offset of 16, and occupying a data size of 16 bytes in the STR data structure **216**. In the illustrated examples, the STR scatter/gather table signature is used to authenticate an Nx8-byte scatter/gather table **310** stored in the STR data structure **216** to confirm that it is valid (e.g., it has not been altered or compromised during the suspend-to-RAM power state **104**). In the illustrated example, the scatter/gather table **310** stores pointers to locations in the system memory **210** storing the protected regions **218** of the platform software.

The STR data structure format **300** of the illustrated example also includes a STR DRAM signature field **306** for storing a STR DRAM signature at a byte offset of 32, and occupying a data size of 16 bytes in the STR data structure **216**. In the illustrated examples, the STR DRAM signature is used to authenticate a DRAM area stipulated in the scatter/gather table **310** stored in the STR data structure **216** to confirm that it is valid (e.g., it has not been altered or compromised during the suspend-to-RAM power state **104**). In the illustrated example, the DRAM area stipulated by the scatter/gather table **310** is pointed to by a pointer stored in a pointer-0 field **312**, and it is the first 16-byte aligned buffer of the protected regions **218** (FIG. 2).

In the illustrated examples, signatures stored in the STR header signature field **302**, the STR scatter/gather table signature field **304**, and the STR DRAM signature field **306** are used to sign the STR data structure **216** when the processor system **100** is transitioning into the suspend-to-RAM power state **104**. In this manner, the stored signatures can be used when resuming the processor system **100** out of the suspend-to-RAM power state **104** to determine whether the STR data structure **216** is valid (e.g., has not been altered or compromised during the suspend-to-RAM power state **104**). For example, potential attackers may modify the information in the STR data structure **216** to point to different regions of the system memory **210** storing malicious software in an attempt to cause the host CPU **202** to execute such malicious code when the processor system **100** resumes to the fully active power state **102**. If such modifications exist in the STR data structure **216**, a verification process performed during a trusted resume of the processor system **100** generates an error based on the signature(s) of one or more of the STR header signature field **302**, the STR scatter/gather table signature field **304**, and/or the STR DRAM signature field **306**.

Although three signature fields **302**, **304**, and **306** are shown in FIG. 3, fewer signatures (e.g., one signature or two signatures) or more signatures (e.g., more than three signatures) may be used with the examples disclosed herein to authenticate/sign the STR data structure **216** and confirm its validity during resume operations. In addition, although specific types of signatures are disclosed herein (e.g., a header signature, a scatter/gather table signature, and a DRAM signature), other types of signatures and/or other manners of generating signatures may be used with examples disclosed herein to authenticate/sign the STR data structure **216** and confirm its validity during resume operations. For example, one or more signatures may be generated based on different information (e.g., more information, less information, or differently segmented information) in the STR data structure **216**, so long as the signature(s) can be used to authenticate/sign the STR data structure **216** when entering a low-power mode, and validate it during a resume process.

The STR header fields **308** of the illustrated example includes an STR data structure version field **316** to indicate a revision of the STR data structure format **300**, and a number of scatter/gather array entries field **318** to indicate the number of scatter/gather entries stored in the scatter/gather table **310**.

In the illustrated example, each scatter/gather entry in the scatter/gather table **310** includes the memory address location and data size of a corresponding memory region in the protected regions **218** (FIG. 2). The scatter/gather table **310** includes the pointer-0 field **312** to store a pointer pointing to the memory address location in the system memory **210** of the first 16-byte aligned buffer that is protected by the STR DRAM signature stored in the STR DRAM signature field **306**. A size-0 field **320** of the scatter/gather table **310** stores the data size in bytes of the first 16-byte aligned buffer. The scatter/gather table **310** of the illustrated example includes a plurality of other pointer/size field pairs **322** indicating memory address locations in system memory **210** and corresponding data sizes of other 16-byte aligned buffers up to an Nth 16-byte aligned buffer corresponding to a pointer-N field **324** and a size-N field **326**. In the illustrated example, the pointer and size fields **312**, **320**, **322**, **324**, and **326** refer to 16-byte aligned buffers in the system memory **210** that store the protected regions **218**. By storing the addresses and sizes of the protected regions **218** in this manner in the STR

data structure **216**, examples disclosed herein can determine whether it is safe to access the protected regions **218** when resuming from the suspend-to-RAM power state **104** by relying on an authentication/signing of the STR data structure **216**.

In the illustrated example, the scatter/gather table **310** is extensible to being a size that is a multiple of 16 bytes. For this extensibility, the scatter/gather table **310** is provided with padding bytes **328**.

Although the example STR data structure format **300** is shown in FIG. **3** in connection with particular data sizes (e.g., 4 bytes, 8 bytes, 16 bytes, 32 bytes, etc.) and byte offsets, other data sizes and/or byte offsets may be used for parameters of the STR data structure format **300** (e.g., data sizes and/or byte offsets of signatures and/or other parameters). Although the scatter/gather table **310** refers to 16-byte aligned buffers, the scatter/gather table **310** may be adapted for use with other buffer sizes. In addition, although pointers and size values in the scatter/gather table **310** are used in the illustrated example to specify locations and sizes of the protected regions **218** (FIG. **2**), other suitable manners for specifying locations and/or sizes of the protected regions **218** may additionally or alternatively be used.

FIGS. **4**, **5**, **6**, **7A**, **7B**, and **8-10** are representative of machine readable instructions that may be executed by the processor system **100** (FIGS. **1** and **2**) to protect regions of memory during low-power states as disclosed herein. In these examples, the machine readable instructions comprise programs for execution by one or more processors such as the host CPU **202** and the secure CPU **204** of FIG. **2**. The programs may be embodied in software stored on a tangible computer readable medium such as a CD-ROM, a floppy disk, a hard drive, a digital versatile disk (DVD), a Blu-ray disk, or a memory associated with the processors **202** and **204**, but the entire program and/or parts thereof could alternatively be executed by a device other than the processors **202** and **204** and/or embodied in firmware or dedicated hardware. Further, although the example programs are described with reference to the flowcharts illustrated in FIGS. **4**, **5**, **6**, **7A**, **7B**, and **8-10**, many other methods of implementing the example processor system **100** may alternatively be used. For example, the order of execution of the blocks may be changed, and/or some of the blocks described may be changed, eliminated, or combined.

As mentioned above, the example processes of FIGS. **4**, **5**, **6**, **7A**, **7B**, and **8-10** may be implemented using coded instructions (e.g., computer readable instructions) stored on a tangible computer readable medium such as a hard disk drive, a flash memory, a read-only memory (ROM), a compact disk (CD), a digital versatile disk (DVD), a cache, a random-access memory (RAM) and/or any other storage media in which information is stored for any duration (e.g., for extended time periods, permanently, brief instances, for temporarily buffering, and/or for caching of the information). As used herein, the term tangible computer readable medium is expressly defined to include any type of computer readable storage and to exclude propagating signals. Additionally or alternatively, the example processes of FIGS. **4**, **5**, **6**, **7A**, **7B**, and **8-10** may be implemented using coded instructions (e.g., computer readable instructions) stored on a non-transitory computer readable medium such as a hard disk drive, a flash memory, a read-only memory, a compact disk, a digital versatile disk, a cache, a random-access memory and/or any other storage media in which information is stored for any duration (e.g., for extended time periods, permanently, brief instances, for temporarily buffering, and/or for caching of the information). As used herein,

the term non-transitory computer readable medium is expressly defined to include any type of computer readable storage device or storage disc and to exclude propagating signals. As used herein, when the phrase “at least” is used as the transition term in a preamble of a claim, it is open-ended in the same manner as the term “comprising” is open ended. Thus, a claim using “at least” as the transition term in its preamble may include elements in addition to those expressly recited in the claim.

FIG. **4** is an example flow diagram representative of computer readable instructions to transition the processor system **100** of FIG. **1** between the active power state **102** (FIG. **1**) and the suspend-to-RAM power state **104** (FIG. **1**) in accordance with the teachings of this disclosure. For a more detailed discussion, FIGS. **5**, **6**, **7A**, **7B**, and **8-10** described below show additional example operations that may be performed to transition the processor system **100** between the active power state **102** and the suspend-to-RAM power state **104** as disclosed herein.

Turning in detail to FIG. **4**, initially, the host CPU **202** (FIG. **2**) receives a low-power mode instruction (block **402**). The low-power mode instruction of the illustrated example is an instruction to transition the processor system **100** (FIGS. **1** and **2**) to the suspend-to-RAM power state **104** (FIG. **1**). The secure CPU **204** (FIG. **2**) adds entries to identify the protected regions **218** in the STR data structure **216** of FIG. **2** (block **404**). For example, the secure CPU **204** stores information indicating the quantity of the protected regions **218** in the number of scatter/gather array entries field **318** (FIG. **3**) of the STR data structure **216** (FIG. **2**), and stores entries in the scatter/gather table **310** (FIG. **3**) of the STR data structure **216** describing the locations and sizes of the protected regions **218**. In the illustrated example, the secure CPU **204** determines which memory regions are to be protected regions **218** based on memory regions specified by a hardware manufacturer in the manufacturer required regions table **224** of FIG. **2** and/or memory regions specified by one or more third parties in the conditional access required regions table **226** of FIG. **2**.

The secure CPU **204** generates signatures (block **406**) for authenticating the STR data structure **216**. For example, the secure CPU **204** generates signatures for storing in the STR header signature field **302**, the STR scatter/gather table signature **304**, and the STR DRAM signature field **306** of FIG. **3**. The secure CPU **204** may use any suitable function for generating the signatures including, for example, a cipher-based message authentication code (CMAC) function, a hash-based message authentication code (HMAC), or any other suitable function for generating signatures. In the illustrated example, the secure CPU **204** generates a STR header signature by applying the signature generating function to the STR header stored in the STR header field **308** (FIG. **3**) of the STR data structure **216**. In the illustrated example, the secure CPU **204** generates a STR scatter/gather table signature by applying the signature generating function to the STR scatter/gather table stored in the STR scatter/gather table **310** (FIG. **3**) of the STR data structure **216**. In the illustrated example, the secure CPU **204** generates a STR DRAM signature by applying the signature generating function to the DRAM area pointed to by the pointer-0 field **312** of the scatter/gather table **310**, and occupying the first 16-byte aligned buffer of the protected regions **218** (FIG. **2**). In some examples, the signature generating function may be used in combination with other data (e.g., random/pseudo-random values) when generating the signatures to add additional authentication strength.

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The secure CPU **204** stores the signatures in the STR data structure **216** (block **408**). For example, the secure CPU **204** stores the signatures in the STR header signature field **302**, the STR scatter/gather table signature field **304**, and the STR DRAM signature field **306** (FIG. 3) of the STR data structure **216** (FIG. 2). The processor system **100** enters the low-power mode (block **410**). In the illustrated example, the low-power mode is the suspend-to-RAM power state **104** of FIG. 1.

At some subsequent time, the processor system **100** receives a resume instruction (block **412**). For example, the processor system **100** receives a wake-on-LAN instruction via the communication subsystem **108** of FIG. 1, or receives a user input via the user interface **112** of FIG. 1, or receives any other suitable input (e.g., a wake-up timer input, a service interrupt, etc.) to transition the processor system **100** from the suspend-to-RAM state **104** to the active state **102**.

The secure CPU **204** reads the STR data structure **216** (block **414**) from the system memory **210**. The secure CPU **204** determines whether the STR data structure **216** is valid (block **416**). For example, the secure CPU **204** re-generates signatures in the same manner as described above in connection with block **406** for comparing against the signatures stored in the STR header signature field **302**, the STR scatter/gather table signature field **304**, and the STR DRAM signature field **306** of FIG. 3. In this manner, the secure CPU **204** can compare each signature generated at block **416** with its corresponding signature generated at block **406** (e.g., the STR header signature, the STR scatter/gather table signature, and the STR DRAM signature) to verify different parts of the STR data structure **216** and confirm whether the STR data structure **216** is valid. If any re-generated signature does not match its corresponding signature from block **406**, then the secure CPU **204** can determine that a potential attack on the processor system **100** is being attempted.

If the secure CPU **204** determines that the STR data structure **216** is valid (block **418**), the host CPU **202** restores the state(s) of the platform software (block **420**). The host CPU **202** enables the active power state **102** of the processor system **100** (block **422**). However, if at block **418** the secure CPU **204** determines that the STR data structure **216** is not valid (e.g., one of the re-generated signatures does not match its corresponding signature generated at block **406** and stored in the STR data structure **216**), the secure CPU **204** returns an error to the host CPU **204** (block **424**). In this manner, the host CPU **204** can prevent the processor system **100** from resuming the active state **100**, and can perform a pre-defined operation or process to prevent an attack on the processor system **100**. In some examples, such a pre-defined operation or process involves initiating a hard reset of the processor system **100**. After enabling the active power state **102** at block **422** or after returning an error at block **424**, the example process of FIG. 4 ends.

FIG. 5 illustrates an example flow diagram representative of computer readable instructions that may be executed to perform a host boot sequence to boot the processor system **100** (FIGS. 1 and 2) during a cold boot or a resume from the suspend-to-RAM power state **104** (FIG. 1). In the illustrated example, the operations up to and including block **518** are performed as part of a stage-1 (S1) boot process, and the operations of blocks **520**, **522**, and **524** are performed during a stage-2 (S2) boot process.

Initially, the host CPU **202** executes host boot ram instructions (block **502**) stored in the host boot ram **208**. The host CPU **202** initializes cache and the flash memory **206** (block **504**). The host CPU **202** initializes external DRAM (block **506**). In the illustrated example, the external DRAM is the

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system memory **210**. In some examples, the host CPU **202** initializes the external DRAM using S1 parameters (stage-1 boot loader parameters) stored in the host boot RAM **208**.

The host CPU **202** sends an ADD regions IPC instruction to the secure CPU **204** via the inter-processor communication path **214** of FIG. 2 (block **508**). In the illustrated example, the host CPU **202** issues the ADD regions IPC instruction so that regions of platform software stored/created during a stage 2 boot process can be designated as protected regions **218** (FIG. 2) so that they can be protected using the signing/authentication techniques disclosed herein.

The host CPU **202** determines whether it is performing a cold boot (block **510**) from a full power-off state. If it is performing a cold boot, the host CPU **202** logs the cold boot (block **512**) and calls a stage-2 authentication sequence (block **514**). Otherwise, if the host CPU **202** determines that it is not performing a cold boot (block **510**), it is resuming from the suspend-to-RAM power state **104** (FIG. 1), and the host CPU **202** calls a verify DRAM process (block **516**). An example process to verify DRAM that may be called at block **516** is described below in connection with FIGS. 7A and 7B.

After calling the stage-2 authentication sequence at block **514**, or after calling the verify DRAM process at block **516**, the host CPU **202** jumps to a stage-2 common entry point (block **518**). In the illustrated example, the stage-2 common entry point allows the host CPU **202** to execute a stage-2 boot process.

During the stage-2 boot process, the host CPU **202** performs other initialization operations (block **520**). Such other initialization operations may include other initializing other portions of the microprocessor subsystem **106** and/or the memory subsystem **110**, initializing portions of the communication subsystem **108**, initializing other portions of the user interface subsystem **112** of FIG. 1, and/or performing any other initializations configured by system designers as needing to occur during the stage-2 boot process.

The host CPU **202** calls a resume switch process (block **522**). An example resume switch process that may be called at block **522** is described below in connection with FIG. 8. In the illustrated examples, the resume switch process enables adding an ACPI table as a protected region **218**. The host CPU **202** then finishes the remainder of the boot operations (block **524**). In the illustrated example, the remaining boot operations that are performed are based on whether the host CPU **202** is performing a cold boot or a resume. The example process of FIG. 5 then ends.

FIG. 6 illustrates an example flow diagram representative of computer readable instructions that may be executed to transition the processor system **100** (FIGS. 1 and 2) to the suspend-to-RAM power state **104** (FIG. 1) from the active power state **102** (FIG. 1). In the illustrated example, the example process of FIG. 6 may be invoked by a user input (e.g., a user pressing/selecting a sleep button), a timeout interrupt, or any other suitable user and/or machine input to transition the processor system **100** to a low-power mode.

Initially, the host CPU **202** freezes applications and middleware (block **602**), for example, from executing any further until the processor system **100** resumes back to the active power state **102**. The host CPU **202** suspends drivers (block **604**). The host CPU **202** adds the protected regions **218** to the STR data structure **216** (block **606**). In the illustrated example, the host CPU **202** adds the protected regions **218** of platform software to the STR data structure **216** by adding location and size information in a scatter/gather table of the STR data structure **216** in accordance

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with the format of the scatter/gather table 310 of FIG. 3. In this manner, the STR data structure 216 can be used to locate the protected regions 218 in the system memory 210. The host CPU 202 sends an IPC instruction to the secure CPU 204 to sign/authenticate the DRAM (block 608). The sign DRAM IPC instruction of the illustrated example causes the secure CPU 204 to sign the STR data structure 216 stored in the system memory 210.

The secure CPU 204 then performs operations to sign the STR data structure 216. Initially, the secure CPU 204 generates a nonce value (block 610). In the illustrated example, the generated nonce value is the random or pseudo-random value 222 of FIG. 2, and it is used to generate signatures for signing/authenticating the STR data structure 216. The signatures of the illustrated example include signatures to be stored in the STR header signature field 302, the STR scatter/gather table signature field 304, and the STR DRAM signature field 306 of FIG. 3. In the illustrated example, the random/pseudo-random value 222 is used for the nonce value to make it difficult for any potential attacker to replay the contents of DRAM.

The secure CPU 204 stores the nonce value (e.g., the random/pseudo-random value 222) and the STR data structure pointer 220 (FIG. 2) in the continuously powered memory 212 (block 612). In this manner, the nonce value (e.g., the random/pseudo-random value 222) and the STR data structure pointer 220 are persisted during the suspend-to-RAM power state 104, and are accessible to resume to the active power state 102, because the continuously powered memory 212 remains powered during the suspend-to-RAM power state 104.

The secure CPU 204 signs the STR data structure 216 of FIG. 2 (block 614). In the illustrated example, the secure CPU signs the STR data structure 216 by generating the signatures corresponding to the STR header signature field 302, the STR scatter/gather table signature field 304, and the STR DRAM signature field 306 of FIG. 3. An example signature process that may be used to implement block 614 is described below in connection with FIG. 9.

The secure CPU 204 stores the STR data structure 216 and the signatures (e.g., the signatures in the STR header signature field 302, the STR scatter/gather table signature field 304, and the STR DRAM signature field 306) in the system memory 210 (block 616). The host CPU 202 transitions the processor system 100 into the suspend-to-RAM power state 104 (block 618). The example process of FIG. 6 then ends.

FIGS. 7A and 7B illustrate an example flow diagram representative of computer readable instructions that may be executed to verify the validity of the protected regions 218 (FIG. 2) in the system memory 210 (FIG. 2) storing data for a software platform operating state. The example process of FIGS. 7A and 7B may be instantiated from block 516 of FIG. 5. As shown in FIG. 7A, initially, the host CPU 202 sends a verify IPC command to the secure CPU 204 (block 700). The verify IPC command causes the secure CPU 204 to perform a verification process to verify the validity of the protected regions 218. The secure CPU 204 reads a nonce value (e.g., the random/pseudo-random value 222) from the continuously powered memory 212 (block 704). In the illustrated example, the nonce value is the random/pseudo-random value 222 (FIG. 2) that was generated at block 610 of FIG. 6 when transitioning the processor system 100 to the suspend-to-RAM power state 104.

The secure CPU 204 overwrites the nonce value (e.g., the random/pseudo-random value 222) in the continuously powered memory 212 (block 706), for example, with any

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random data. In the illustrated example, overwriting the nonce value in this manner guards against replay attacks by not leaving the nonce value exposed for re-use by potential attackers. The secure CPU 204 reads the STR data structure pointer 220 from the continuously powered memory 212 (block 708). The secure CPU 204 uses the STR data structure pointer 220 to locate and read the STR data structure 216 (FIG. 2) from the system memory 210 (block 710). The secure CPU 204 verifies the validity of the STR data structure 216 (block 712). An example process that may be used to verify the validity of the STR data structure 216 at block 712 is described below in connection with FIG. 10.

The secure CPU 204 determines whether the signatures are verified (block 714) (FIG. 7B). In the illustrated example, the signatures that are checked for validity are the signatures of the signatures in the STR header signature field 302, the STR scatter/gather table signature field 304, and the STR DRAM signature field 306 of FIG. 3. If the secure CPU 204 determines at block 714 that one or more of the signatures is/are not verified as valid, the secure CPU 204 generates an error (block 716). After generating the error at block 716, or if the secure CPU 204 determines at block 714 that all of the signatures are verified as valid, the secure CPU 204 reads the CA required region table 226 of FIG. 2 (block 718). The secure CPU 204 also reads the manufacturer required region table 224 of FIG. 2 (block 720). In the illustrated example, the secure CPU 204 may retrieve the CA required region table 226 and the manufacturer required region table 224 from the host boot RAM 208 at addresses provided by the host CPU 202. For example, the addresses at which the CA required region table 226 and the manufacturer required region table 224 are located may be stored as pointers in S1 parameters, and may be retrieved by the host CPU 202 from the S1 parameters.

The secure CPU 204 determines whether the regions specified in the CA required regions table 226 are covered by the STR data structure 216 (block 722). For example, the secure CPU 204 compares the regions specified in the CA required regions table 226 to the protected regions 218 specified in the scatter/gather table 310 (FIG. 3) of the STR data structure 216. If the regions specified in the CA required regions table 226 are not covered by the STR data structure 216 (block 722), the secure CPU 204 generates an error (block 724). After generating the error at block 724, or if the secure CPU 204 determines at block 722 that the regions specified in the CA required regions table 226 are covered by the STR data structure 216, the secure CPU 204 determines whether the regions specified in the manufacturer required regions table 224 are covered by the STR data structure 216 (block 726). For example, the secure CPU 204 compares the regions specified in the manufacturer required regions table 224 to the protected regions 218 specified in the scatter/gather table 310 (FIG. 3) of the STR data structure 216. If the regions specified in the manufacturer required regions table 224 are not covered by the STR data structure 216 (block 726), the secure CPU 204 generates an error (block 728). After generating the error at block 728, or if the secure CPU 204 determines at block 726 that the regions specified in the manufacturer required regions table 224 are covered by the STR data structure 216, the secure CPU 204 returns a status to the host CPU 202 (block 730) indicating, for example, whether any verification errors were generated, whether the signatures were successfully verified as valid at block 714, and/or whether the regions specified in the CA required regions table 226 and the manufacturer required regions table 224 are covered by the STR data structure 216.

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The host CPU 202 determines whether the DRAM (e.g., the system memory 210) is verified as valid (block 732), for example, based on the status (e.g., an error status or a verification success status) received from the secure CPU 204. If the DRAM is not verified, the host CPU 202 performs a hardware reset (block 734). In the illustrated example, when the DRAM is not verified, it is possible that an attack could be made on the processor system 100. As such, a hardware reset is used at block 734 to re-initialize the processor system 100 to boot anew from a cold boot state so that contents of the system memory 210 are discarded and are re-loaded and/or re-initialized. After performing the hardware reset 734, or if the DRAM is verified as valid at block 732, the example process of FIGS. 7A and 7B ends and/or returns to a calling function or process such as the example process of FIG. 5.

FIG. 8 illustrates an example flow diagram representative of computer readable instructions that may be executed to boot the processor system 100 (FIGS. 1 and 2) under a cold boot process or a suspend-to-RAM resume process. The example process of FIG. 8 may be instantiated by the call resume switch operation of block 522 of FIG. 5. Initially, the host CPU 202 reads a cold boot resume flag from an on-chip register (block 802). For example, the cold boot resume flag may be set in an on-chip register in the host CPU 202 to indicate whether the boot process is a cold boot process, or is a resume process to transition the processor system 100 from a low-power mode such as the suspend-to-RAM power state 104 to the active power state 102 of FIG. 1.

The host CPU 202 determines whether the boot process is a cold boot or a resume (block 804) based on the cold boot resume flag read at block 802. If the boot process is a cold boot (block 804), the host CPU 202 generates an ACPI table (block 806) and adds the ACPI table to the protected regions 218 (block 808) as part of a CEFDK (Consumer Electronics Firmware Development Kit) stage-2 process. In the illustrated example, the ACPI table is added to the protected regions 218 so that the ACPI table is protected by the signing/authentication of the STR data structure 216. The host CPU 202 sets a wake vector in the ACPI table (block 810) as part of an operating system process. Control then returns to a cold boot path (e.g., in FIG. 5), and the example process of FIG. 8 ends.

If the host CPU 202 determines at block 804 that the boot process is a resume, the host CPU 202 reads a previously generated and stored ACPI table (block 812), and uses a wake vector in the ACPI table as an entry point in an operating system (block 814) as part of a CEFDK stage-2 process to proceed with the resume process. In the illustrated example, the ACPI table accessed at blocks 812 and 814 may be an ACPI table generated and stored in the protected regions 218 during a cold boot process (e.g., at blocks 806 and 808), and the wake vector used at block 814 may be a wake vector set during the cold boot process (e.g., at block 810). Control then jumps to a resume entry point, and the example process of FIG. 8 ends.

FIG. 9 illustrates an example flow diagram representative of computer readable instructions that may be executed to generate signatures useable to authenticate/sign the STR data structure 216 of FIG. 2. The example process of FIG. 9 may be used to implement the operation of block 614 of FIG. 6. The example process of FIG. 9 generates keys used to generate the signatures of the STR header signature field 302, the STR scatter/gather table signature field 304, and the STR DRAM signature field 306 of FIG. 3 to sign the STR data structure 216 of FIG. 2. The keys generated in the process of FIG. 9 are on-die secret keys that are handled

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securely so that they are not accessible by the host software. In the illustrated example, to ensure the security of the keys, only the secure CPU 204 is able to generate the keys. In addition, the secure CPU 204 of the illustrated example is configured to generate the keys using a process that enables the secure CPU 204 to identically re-create or re-generate the keys at later times by, for example, seeding an on-die key generator with the same value when a key needs to be re-created. The keys of the illustrated example are identically re-creatable so that the secure CPU 204 can sign the STR data structure 216 based on keys generated during a transition to the suspend-to-RAM power state 104, and so that upon resuming from the suspend-to-RAM power state 104, the secure CPU 204 can generate the same keys for use in confirming the authentication/signing of the STR data structure 216 that occurred when entering the suspend-to-RAM power state 104.

As shown in FIG. 9, initially, the secure CPU 204 generates an STR root generation key (block 902). In the illustrated example, the secure CPU 204 uses the STR root generation key to generate subsequent keys for generating the signatures of the STR header signature field 302, the STR scatter/gather table signature field 304, and the STR DRAM signature field 306 of FIG. 3. The secure CPU 204 generates an STR header key (block 904) using the STR root generation key. The secure CPU 204 generates an STR header signature (block 906), for example, corresponding to the STR header signature field 302. In the illustrated example, the secure CPU 204 generates the STR header signature by applying a signature function (e.g., a CMAC function, an HMAC function, etc.) to the STR header key generated at block 904, and a concatenation of an STR header (e.g., stored in the STR header 308 of FIG. 3) and a nonce value (e.g., the random/pseudo-random value 222 of FIG. 2). For example, the signature generation function used at block 906 may be SIGNATURE(STR HEADER KEY, CONCATENATE(STR HEADER, NONCE)).

The secure CPU 204 generates an STR scatter/gather table key (block 908) using the STR root generation key. The secure CPU 204 generates an STR scatter/gather table signature (block 910), for example, corresponding to the STR scatter/gather table 310 of FIG. 3. In the illustrated example, the secure CPU 204 generates the STR scatter/gather table signature by applying a signature function (e.g., a CMAC function, an HMAC function, etc.) to the STR scatter/gather table key generated at block 908, and a concatenation of information stored in the STR scatter/gather table 310 (e.g., pointer and size information stored in the fields 312, 320, 322, 324, 326, and 328 of the STR scatter/gather table 310 of FIG. 3) and a nonce value (e.g., the random/pseudo-random value 222 of FIG. 2). For example, the signature generation function used at block 906 may be SIGNATURE(STR SCATTER/GATHER TABLE KEY, CONCATENATE(SCATTER/GATHER TABLE, NONCE)).

The secure CPU 204 generates an STR DRAM key (block 912) using the STR root generation key. The secure CPU 204 generates an STR DRAM signature (block 914), for example, corresponding to the first 16-byte aligned buffer of the protected regions 218 pointed to by a pointer stored in the pointer-0 field 312 of the scatter/gather table 310. In the illustrated example, the secure CPU 204 generates the STR DRAM signature by applying a signature function (e.g., a CMAC function, an HMAC function, etc.) to the STR DRAM key generated at block 912, and a concatenation of the 16-byte aligned buffer of the protected regions 218 pointed to by the pointer in the pointer-0 field 312, and a

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nonce value (e.g., the random/pseudo-random value **222** of FIG. 2). For example, the signature generation function used at block **914** may be SIGNATURE(STR DRAM KEY, CONCATENATE(STR DRAM AREA, NONCE)).

The secure CPU **204** destroys the keys generated at blocks **902**, **904**, **908**, and **912** (block **916**). Destroying the keys provides further protection against the keys being accessed in undesirable manners. The example process of FIG. 9 returns the STR header signature, the STR SG table signature, and the STR DRAM key (block **918**) to a calling function or process such as the example process of FIG. 6. The example process of FIG. 9 then ends.

Although the example process of FIG. 9 is described as generating three signatures (i.e., the signatures generated at blocks **906**, **910**, and **914**), in other examples, fewer signatures (e.g., one signature or two signatures) or more signatures (e.g., more than three signatures) may be generated for use in authenticating/signing the STR data structure **216**.

FIG. 10 illustrates an example flow diagram representative of computer readable instructions that may be executed to verify the validity the STR data structure **216** (FIG. 2). The example process of FIG. 10 may be used to implement the operation of **712** of FIG. 7A when verifying DRAM during a resume process from the suspend-to-RAM power state **104** of FIG. 1. To confirm the validity of the STR data structure **218**, the example process is used to generate keys and signatures in the same manner as described above in connection with FIG. 9. As discussed above, the keys used to generate the signatures are identically re-creatable by the secure CPU **204** at subsequent times, for example, by seeding a key generator with the same seed value as used in the process of FIG. 9. The keys are then used to generate signatures based on the STR data structure **216** to compare against the signatures stored in the STR data structure **216** (e.g., in the STR header signature field **302**, the STR scatter/gather table signature field **304**, and the STR DRAM signature field **306** of FIG. 3). Because the keys generated in the example process of FIG. 10 are identical to the keys generated in the example process of FIG. 9, the signatures generated in the verification process of FIG. 10 when resuming from the suspend-to-RAM power state **104** should match the signatures generated in the authentication process of FIG. 9 when entering the suspend-to-RAM power state **104**, if the contents of the STR data structure **216** have not been altered (e.g., have not been compromised by a potential attacker).

As shown in FIG. 10, initially, the secure CPU **204** generates a STR root generation key (block **1002**). For example, the secure CPU **204** can generate the STR root generation key in the same manner as it generated the STR root generation key at block **902** of FIG. 9. The secure CPU **204** generates a STR header key (block **1004**), for example, in the same manner as it generated the STR header key at block **904** of FIG. 9. The secure CPU **204** generates an STR header signature (block **1006**), for example, in the same manner as it generated the STR header signature (e.g., of the STR header signature field **302**) at block **906** of FIG. 9.

The secure CPU **204** verifies the STR header of the STR data structure **216** (block **1008**). For example, the secure CPU **204** compares the STR header signature generated at block **1006** to the STR header signature stored in the STR data structure **216** (e.g., in the STR header signature field **302** of FIG. 3) to determine whether the STR header (e.g., the STR header in the STR header field **308** of FIG. 3) of the STR data structure **216** is valid. If the STR header has not changed since the processor system **100** entered the sus-

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pend-to-RAM power state **104**, the signatures will match to confirm that the STR header is valid.

The secure CPU **204** generates an STR scatter/gather table key (block **1010**), for example, in the same manner as it generated the STR scatter/gather table key at block **908** of FIG. 9. The secure CPU **204** generates an STR scatter/gather table signature (block **1012**), for example, in the same manner as it generated the STR scatter/gather table signature at block **910** of FIG. 9. The secure CPU **204** verifies the STR scatter/gather table of the STR data structure **216** (block **1014**). For example, the secure CPU **204** compares the STR scatter/gather signature generated at block **1006** to the STR scatter/gather signature stored in the STR data structure **216** (e.g., in the STR scatter/gather signature field **304** of FIG. 3) to determine whether the STR scatter/gather table (e.g., the STR scatter/gather table location and size information in the STR scatter/gather table **310** of FIG. 3) of the STR data structure **216** is valid. If the STR scatter/gather table information has not changed since the processor system **100** entered the suspend-to-RAM power state **104**, the signatures will match to confirm that the STR scatter/gather table information is valid.

The secure CPU **204** generates an STR DRAM key (block **1016**), for example, in the same manner as it generated the STR DRAM key at block **912** of FIG. 9. The secure CPU **204** generates an STR DRAM signature (block **1018**), for example, in the same manner as it generated the STR DRAM signature at block **914** of FIG. 9. The secure CPU **204** verifies the STR DRAM area pointed to by the STR data structure **216** (block **1020**). For example, the secure CPU **204** compares the STR DRAM signature generated at block **1018** to the STR DRAM signature stored in the STR data structure **216** (e.g., in the STR DRAM signature field **306** of FIG. 3) to determine whether the 16-byte aligned buffer of the protected regions **218** pointed to by the pointer-0 **312** of FIG. 3 is valid. If the information in the 16-byte aligned buffer has not changed since the processor system **100** entered the suspend-to-RAM power state **104**, the signatures will match to confirm that the 16-byte aligned buffer of the protected regions **218** pointed to by the pointer in the pointer-0 field **312** is valid.

The secure CPU **204** destroys the keys generated at blocks **1002**, **1004**, **1010**, and **1016** (block **1022**). Destroying the keys provides further protection against the keys being accessed in undesirable manners. The example process of FIG. 10 returns the verification status to a calling function or process such as the example process of FIGS. 7A and 7B, and the example process of FIG. 10 ends.

Although the example process of FIG. 10 is described as generating three signatures (i.e., the signatures generated at blocks **1006**, **1012**, and **1018**), in other examples, fewer signatures (e.g., one signature or two signatures) or more signatures (e.g., more than three signatures) may be generated for use in verifying the validity of the STR data structure **216**. In any case, the same number of signature(s) should be generated in the example process of FIG. 10 as generated in the example process of FIG. 9.

Disclosed example methods manage power states in a processor system. Some disclosed example methods involve, when transitioning a processor system to a low-power mode, generating at least a first signature based on a data structure storing memory addresses of memory regions to be protected during the low-power mode. Some disclosed example methods also involve, during a resume process of the processor system from the low-power mode, generating at least a second signature based on the data structure storing the memory addresses of the memory regions to be protected

during the low-power mode. Some disclosed example methods also involve resuming the processor system from the low-power mode when the first signature matches the second signature, and/or generating an error when the first signature does not match the second signature. In some examples, the low-power mode is a suspend-to-random access memory power state in which operating states of platform software are stored in a random access memory that remains powered during the suspend-to-random access memory power state.

Some disclosed examples also involve generating at least one key and a random or pseudo-random value, and using the at least one key and the random or pseudo-random value in combination with information in the data structure to generate the first signature. In some examples, the information in the data structure includes at least one of a data structure header or memory addresses and data sizes of the protected memory regions. Some disclosed examples also involve re-generating the at least one key, retrieving the random or pseudo-random value from a continuously powered memory during the resume process, and using the re-generated key and the retrieved random or pseudo-random value to generate the second signature.

Some disclosed examples also involve determining at least one or some of the memory regions to be protected based on a manufacturer required regions table in which a hardware manufacturer of the processor system or a component of the processor system specifies the at least some of the memory regions to be protected. Some disclosed examples also involve determining another of the memory regions to be protected based on a third-party required regions table in which a third party specifies the another of the memory regions to be protected.

Some disclosed examples also involve storing a pointer to the data structure in a continuously powered memory during the low-power mode. Some disclosed examples also involve retrieving the pointer from the continuously powered memory during the resume process, and locating the data structure during the resume process based on the pointer.

Also disclosed are example tangible computer readable storage media comprising example disclosed instructions that, when executed, cause a machine to perform at least some example methods disclosed herein.

Disclosed example apparatus suspend a processor system. Some disclosed example apparatus include a first memory, and a processor in communication with the first memory. In some examples, the first memory is to remain powered when the processor system is in a low-power mode, and the first memory is to store a random or pseudo-random value, and a pointer to a data structure. In some examples, the data structure is to store at least a first signature to authenticate information stored in the data structure that specifies memory regions to store an operating state of the processor system during the low-power mode. In some examples, the processor is to generate the first signature based on the data structure and the random or pseudo-random value when the processor system is transitioning to the low-power mode. In some examples, when the processor system is in a resume process to resume from the low-power mode, the processor is to generate at least a second signature based on the data structure and the random or pseudo-random value, and determine whether the data structure is valid based on a comparison of at least the first signature and the second signature. In some examples, the low-power mode is a suspend-to-random access memory power state in which the operating state is stored in a random access memory that remains powered during the suspend-to-random access

memory power state. In some examples, the first memory is an embedded static random access memory, and example apparatus further comprise a dynamic random access memory to store the data structure.

In some examples, the processor is further to determine at least some of the memory regions based on a manufacturer required regions table in which a hardware manufacturer of the processor system or a component of the processor system specifies the at least some of the memory regions. In some examples, the processor is further to determine a second one of the memory regions based on a third-party required regions table in which a third party specifies the second one of the memory regions. In some examples, the processor is to generate the first and second signatures based on at least one of a data structure header or memory addresses and data sizes of the protected memory regions.

In some examples, the processor is a secure processor in communication with a host processor. In such some examples, when the data structure is not valid based on the comparison of at least the first signature and the second signature, the secure processor is to communicate an error status to the host processor, and the host processor is to perform a hardware reset based on the error status.

Although certain example methods, apparatus and articles of manufacture have been described herein, the scope of coverage of this patent is not limited thereto. On the contrary, this patent covers all methods, apparatus and articles of manufacture fairly falling within the scope of the claims of this patent.

What is claimed is:

1. An apparatus to manage power states in a processor system, comprising:

a memory to remain powered when a processor system is in a low-power mode;

a secure processor in communication with the memory, the secure processor to sign a suspend-to-RAM (STR) data structure in response to a low-power mode instruction by:

generating a STR header key, a STR scatter/gather table key and a dynamic random access memory (DRAM) key using a root key generated by the secure processor;

generating a STR header signature using the STR header key, the STR header signature based on a STR table header and a random or pseudo-random value;

generating a STR scatter/gather table signature using the STR scatter/gather table key, the STR scatter/gather table signature based on a STR scatter/gather table header and a random or pseudo-random value;

generating a DRAM signature using the DRAM key and a value from a region of DRAM; and

storing the STR header signature, the STR scatter/gather table signature and the DRAM signature in the STR data structure; and

a host processor to:

resume the processor system from the low-power mode when the STR data structure is valid based on a comparison of a first signature and a second signature, the first signature based on at least one of the STR header signature, the STR scatter/gather table signature or the DRAM signature, the second signature generated in response to a resume instruction.

2. The apparatus of claim 1, wherein memory addresses of memory regions to be protected during the low-power mode are stored in the STR data structure, the memory regions

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including a first region based on a manufacturer required regions table and a second region based on a third-party required regions table.

3. The apparatus of claim 1, wherein the value from a region of DRAM used to generate the DRAM signature corresponds to a first 16-byte aligned buffer of protected regions pointed to by a pointer stored in a pointer field of the scatter/gather table.

4. The apparatus of claim 1, wherein the low-power mode is a suspend-to-random access memory power state in which an operating state is stored in a random access memory that remains powered during the suspend-to-random access memory power state.

5. The apparatus of claim 1, wherein the secure processor is to destroy the STR header key, the STR scatter/gather table key and the dynamic random access memory (DRAM) key after the STR header signature, the STR scatter/gather table signature and the DRAM signature have been generated.

6. The apparatus of claim 1, wherein the host processor is in communication with the secure processor, and when the data structure is not valid based on the comparison of the first signature and the second signature:

the secure processor is to communicate an error status to the host processor; and

the host processor is to perform a hardware reset based on the error status.

7. The apparatus of claim 1, further including an on-die key generator to generate a key during a resume process:

the on-die key generator is to re-generate the key; and the secure processor is to access the random or pseudo-random value from a continuously powered memory, and use the re-generated key and the random or pseudo-random value to generate the second signature.

8. An method to manage power states in a processor system, comprising:

configuring a secure processor to:

sign a suspend-to-RAM (STR) data structure by:

generating a STR header key, a STR scatter/gather table key and a dynamic random access memory (DRAM) key using a root key generated by the secure processor;

generating a STR header signature using the STR header key, the STR header signature based on a STR table header and a random or pseudo-random value;

generating a STR scatter/gather table signature using the STR scatter/gather table key, the STR scatter/gather table signature based on a STR scatter/gather table header and a random or pseudo-random value;

generating a DRAM signature using the DRAM key and a value from a region of DRAM; and

storing the STR header signature, the STR scatter/gather table signature and the DRAM signature in the STR data structure; and

resume the processor system from the low-power mode when the STR data structure is valid based on a comparison of a first signature and a second signature, the first signature based on at least one of the STR header signature, the STR scatter/gather table signature or the DRAM signature, the second signature generated in response to a resume instruction.

9. The method of claim 8, wherein memory addresses of memory regions to be protected during the low-power mode are stored in the STR data structure, the memory regions

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including a first region based on a manufacturer required regions table and a second region based on a third-party required regions table.

10. The method of claim 8, wherein the value from a region of DRAM used to generate the DRAM signature corresponds to a first 16-byte aligned buffer of protected regions pointed to by a pointer stored in a pointer field of the scatter/gather table.

11. The method of claim 8, wherein the low-power mode is a suspend-to-random access memory power state in which an operating state is stored in a random access memory that remains powered during the suspend-to-random access memory power state.

12. The method of claim 8, further including destroying the STR header key, the STR scatter/gather table key and the dynamic random access memory (DRAM) key after the STR header signature, the STR scatter/gather table signature and the DRAM signature have been generated.

13. The method of claim 8, further including, when the data structure is not valid based on the comparison of the first signature and the second signature:

communicating an error status to a host processor; and performing, via the host processor, a hardware reset based on the error status.

14. The method of claim 8, further including, during the resume process:

re-generating the key via the secure processor;

accessing, via the secure processor, the random or pseudo-random value from a continuously powered memory; and

using, via the secure processor, the re-generated key and the random or pseudo-random value to generate the second signature.

15. An integrated circuit comprising instructions that, when executed, cause a machine to at least:

when transitioning a processor system to a low-power mode, sign a suspend-to-RAM (STR) data structure by: generating a STR header key, a STR scatter/gather table key and a dynamic random access memory (DRAM) key using a root key generated by a secure processor; generating a STR header signature using the STR header key, the STR header signature based on a STR table header and a random or pseudo-random value;

generating a STR scatter/gather table signature using the STR scatter/gather table key, the STR scatter/gather table signature based on a STR scatter/gather table header and a random or pseudo-random value;

generating a DRAM signature using the DRAM key and a value from a region of DRAM; and

storing the STR header signature, the STR scatter/gather table signature and the DRAM signature in the STR data structure; and

resume the processor system from the low-power mode when the STR data structure is valid based on a comparison of a first signature and a second signature, the first signature based on at least one of the STR header signature, the STR scatter/gather table signature or the DRAM signature, the second signature generated in response to a resume instruction.

16. The integrated circuit of claim 15, wherein memory addresses of memory regions to be protected during the low-power mode are stored in the STR data structure, the memory regions including a first region based on a manufacturer required regions table and a second region based on a third-party required regions table.

17. The integrated circuit of claim 15, wherein the value from a region of DRAM used to generate the DRAM signature corresponds to a first 16-byte aligned buffer of protected regions pointed to by a pointer stored in a pointer field of the scatter/gather table.

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18. The integrated circuit of claim 15, wherein the low-power mode is a suspend-to-random access memory power state in which an operating state is stored in a random access memory that remains powered during the suspend-to-random access memory power state.

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19. The integrated circuit of claim 15, wherein the instructions are further to cause the machine to destroy the STR header key, the STR scatter/gather table key and the dynamic random access memory (DRAM) key after the STR header signature, the STR scatter/gather table signature and the DRAM signature have been generated.

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20. The integrated circuit of claim 15, wherein when the data structure is not valid based on the comparison of the first signature and the second signature, the instructions are to further cause the machine to:

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- communicate an error status to a host processor; and
- perform a hardware reset based on the error status.

21. The integrated circuit of claim 15, wherein the instructions are further to cause the machine to, during the resume process:

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- re-generate the key;
- access the random or pseudo-random value from a continuously powered memory; and
- use the re-generated key and the random or pseudo-random value to generate the second signature.

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